



# Product Change Notification

## 108859 - 02

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 108859 - 02  
**Change Title:** STORAGE, SSR212MC2BR,  
SSR212MC2RBR, FMCCHASSIS,  
FMCFANSHS, PCN 108859-02, Product  
Material, ECO Updated FW/SW, Backplane  
Update, Board Spin, Documentation,  
Conversion to LiON Battery Cell Technology  
and Fan Handle Change., Reason for  
Revision: Remove Star Lake board update to  
E11025-301 item. BOIS version update and  
implementation date change.  
**Date of Publication:** October 24, 2008

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Nov 21, 2008
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## Description of Change to the Customer:

**Reason for Revision: Remove Star Lake board update to E11025-301 item. BOIS version update and implementation date change.**

### SSR212MC2BR

1. Updated backplane to correct LED behavior.
2. Updated power supply unit module.
3. The fan handle changes to green plastic for better visibility of the serviceability touch point.
4. S5000PSLSASR server board BIOS updated to 94.
5. S5000PSLSASR server board FRUSDR updated to 46.
6. S5000PSLSASR server board BMC updated to 64.
7. Enclosure management card firmware updated to -60.
8. RAID Controller SRCAS144E updated to firmware -471.

### SSR212MC2RBR

1. Updated backplane to correct LED behavior.
2. Updated power supply unit module.
3. The fan handle changes to green plastic for better visibility of the serviceability touch point.
4. AXXRIBBU1 is converted from NiMH battery cell technology to LiON battery cell technology.

5. S5000PSLSASR server board BIOS updated to 94.
6. S5000PSLSASR server board FRUSDR updated to 46.
7. S5000PSLSASR server board BMC updated to 64.
8. Enclosure management card firmware updated to -60.
9. RAID Controller SRCAS144E updated to firmware -471.

**FMCFANSHS**

1. The fan handle changes to green plastic for better visibility of the serviceability touch point.
2. Installation guide updated to D91600-003.

**FMCCHASIS**

1. Updated backplane to correct LED behavior.
2. Updated power supply unit module.

**Customer Impact of Change and Recommended Action:**

Intel anticipates no impact to customer.

**Products Affected / Intel Ordering Codes:**

Pre Change Product Code	Pre Change MM#	Pre Change TA	Post Change Product Code	Post Change MM#	Post Change TA
SSR212MC2RBR 893519	893519	D88965-007	SSR212MC2RBR	893519	D88965-008
SSR212MC2BR 893628	893628	D88964-007	SSR212MC2BR	893628	D88964-008
FMCCHASIS 896728	896728	D89362-003	FMCCHASIS	896728	D89362-004
FMCFANSHS 891941	891941	E12588-001	FMCFANSHS	891941	E12588-002
AMC850WPS 890400	890400	D89372-001	AMC850WPS	890400	D89372-002

**Reference Documents / Attachments:**

**Document:** \_\_\_\_\_ **Location #:** \_\_\_\_\_

**PCN Revision History:**

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
October 7, 2008	00	Originally Published PCN
October 14, 2008	01	Update Products Affected table with power supply code
October 24, 2008	02	Remove Star Lake board update to E11025-301 item. BOIS version update and implementation date change.